

April 1988 Revised September 2000

74F377

Octal D-Type Flip-Flop with Clock Enable

General Description

The 74F377 has eight edge-triggered, D-type flip-flops with individual D inputs and Q outputs. The common buffered Clock (CP) input loads all flip-flops simultaneously, when the Clock Enable $(\overline{\text{CE}})$ is LOW.

The register is fully edge-triggered. The state of each D input, one setup time before the LOW-to-HIGH clock transition, is transferred to the corresponding flip-flop's Q output. The $\overline{\text{CE}}$ input must be stable only one setup time prior to the LOW-to-HIGH clock transition for predictable operation.

Features

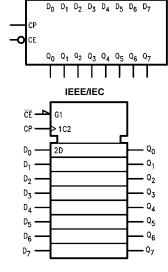
- Ideal for addressable register applications
- Clock enable for address and data synchronization applications
- Eight edge-triggered D-type flip-flops
- Buffered common clock
- See 74F273 for master reset version
- See 74F373 for transparent latch version
- See 74F374 for 3-STATE version

Ordering Code:

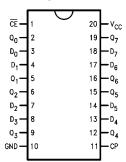
Order Number	Package Number	Package Description
74F377SC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
74F377SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74F377PC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" tot he ordering code.

Logic Symbols



Connection Diagram



Unit Loading/Fan Out

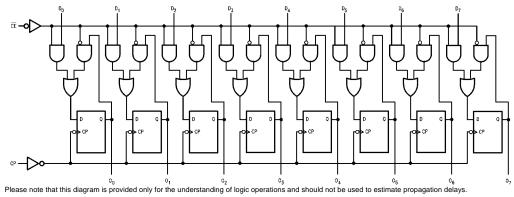
Pin Names	Description	U.L.	Input I _{IH} /I _{IL}	
Pin Names	Description	HIGH/LOW	Output I _{OH} /I _{OL}	
D ₀ –D ₇	Data Inputs	1.0/1.0	20 μA/-0.6 mA	
CE	Clock Enable (Active LOW)	1.0/1.0	20 μA/-0.6 mA	
СР	Clock Pulse Input	1.0/1.0	20 μA/–0.6 mA	
Q ₀ –Q ₇	Data Outputs	50/33.3	−1 mA/20 mA	

Mode Select-Function Table

		Inputs					
Operating Mode	СР	CE	D _n	Q _n			
Load "1"	~	1	h	Н			
Load "0"	~	1	I.	L			
Hold	~	h	Х	No Change			
(Do Nothing)	Х	Н	Х	No Change			
H = HIGH Voltage Level h = HIGH Voltage Level one setup time prior to the LOW L = LOW Voltage Level I = LOW Voltage Level one setup time prior to the LOW- X = Immaterial							

- = LOW-to-HIGH Clock Transition

Logic Diagram



Absolute Maximum Ratings(Note 1)

Recommended Operating Conditions

 $\begin{array}{ll} \mbox{Storage Temperature} & -65^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \mbox{Ambient Temperature under Bias} & -55^{\circ}\mbox{C to } +125^{\circ}\mbox{C} \\ \end{array}$

Input Current (Note 2)

-30 mA to +5.0 mA

Voltage Applied to Output

in HIGH State (with V_{CC} = 0V)

 $\begin{array}{ll} \mbox{Standard Output} & -0.5\mbox{V to V}_{\mbox{CC}} \\ \mbox{3-STATE Output} & -0.5\mbox{V to +5.5\mbox{V}} \end{array}$

Current Applied to Output

in LOW State (Max) ${\rm twice\ the\ rated\ I_{OL}\ (mA)}$ ESD Last Passing Voltage (Min) ${\rm 4000V}$

Free Air Ambient Temperature 0° C to +70°C Supply Voltage +4.5V to +5.5V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

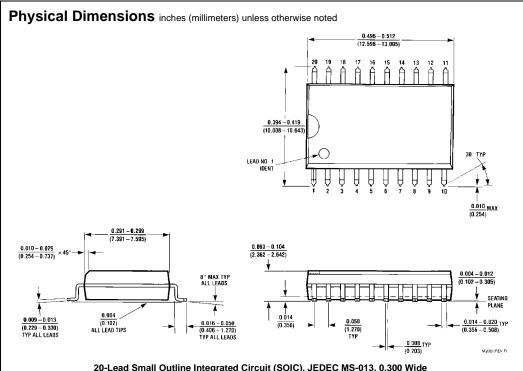
Symbol	Parameter	Min	Тур	Max	Units	V _{cc}	Conditions
V _{IH}	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V _{IL}	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V _{CD}	Input Clamp Diode Voltage			-1.2	V	Min	I _{IN} = -18 mA
V _{OH}	Output HIGH 10% V _{CC}	2.5			V	Min	I _{OH} = -1 mA
	Voltage 5% V _{CC}	2.7			V	IVIIII	$I_{OH} = -1 \text{ mA}$
V _{OL}	Output LOW Voltage 10% V _{CC}			0.5	V	Min	I _{OL} = 20 mA
I _{IH}	Input HIGH Current			5.0	μΑ	Max	V _{IN} = 2.7V
I _{BVI}	Input HIGH Current			7.0	μА	Max	V _{IN} = 7.0V
	Breakdown Test			7.0	μΛ	IVIAX	V _{IN} = 7.0V
I _{IL}	Input LOW Current			-0.6	mA	Max	$V_{IN} = 0.5V$
Ios	Output Short-Circuit Current	-60		-150	mA	Max	V _{OUT} = 0V
I _{CEX}	Output HIGH Leakage Current			50	μΑ	Max	$V_{OUT} = V_{CC}$
V _{ID}	Input Leakage	4.75			V	0.0	I _{ID} = 1.9 μA
	Test	4.75			V	0.0	All Other Pins Grounded
I _{OD}	Output Leakage			3.75	μА	0.0	V _{IOD} = 150 mV
	Circuit Current			3.73	μА	0.0	All Other Pins Grounded
I _{CCH}	Power Supply Current		35	46	mA	Max	CP =
I _{CCL}			44	56	111/5	IVIAA	$D_n = \overline{MR} = HIGH$

AC Electrical Characteristics

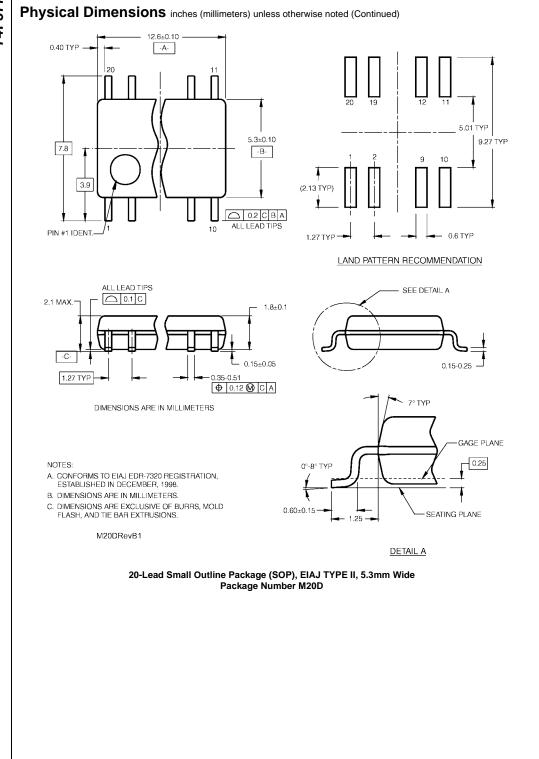
Symbol	Parameter	$T_{A} = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_{L} = 50 \text{ pF}$			$T_A = -55 ^{\circ} C \text{ to } +125 ^{\circ} C$ $V_{CC} = +5.0 V$ $C_L = 50 \text{ pF}$		$T_A = 0$ °C to +70°C $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$		Units
		Min	Тур	Max	Min	Max	Min	Max	
f _{MAX}	Maximum Clock Frequency	130			85		105		MHz
t _{PLH}	Propagation Delay	3.0		7.0	2.0	8.5	2.5	7.5	ns
t _{PHL}	CP to Q _n	4.0		9.0	3.0	10.5	3.5	9.0	115

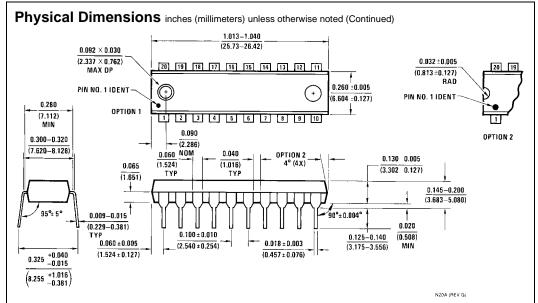
AC Operating Requirements

		$T_A = +25^{\circ}C$ $V_{CC} = +5.0V$		$T_A = -55$ °C to +125°C $V_{CC} = +5.0V$		$T_A = 0$ °C to +70°C $V_{CC} = +5.0V$		Units	
Symbol	Parameter								
		Min	Max	Min	Max	Min	Max	İ	
t _S (H)	Setup Time, HIGH or LOW	3.0		3.5		3.0		no	
t _S (L)	D _n to CP	3.5		4.0		3.5		ns	
t _H (H)	Hold Time, HIGH or LOW	0.5		1.0		0.5		ns	
t _H (L)	D _n to CP	1.0		1.0		1.0		115	
t _S (H)	Setup Time, HIGH or LOW	4.1		4.0		4.1		ns	
t _S (L)	CE to CP	3.5		5.0		4.0		115	
t _H (H)	Hold Time, HIGH to LOW	0.5		1.5		0.5		no	
t _H (L)	CE to CP	2.0		2.5		2.0		ns	
t _W (H)	Clock Pulse Width,	6.0		5.0		6.0		ns	
$t_W(L)$	HIGH or LOW	6.0		5.0		6.0		115	



20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide Package Number M20B





20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N20A

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